

8A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber

MECHANICAL DATA

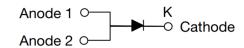
- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.104g (approximately)

KEY PARAMETERS			
PARAMETER VALUE UNI			
I _F	8	Α	
V_{RRM}	200 - 1000	V	
I _{FSM}	230	Α	
T_{JMAX}	150	°C	
Package	TO-277A (SMPC4.6U)		
Configuration	Single die		





TO-277A (SMPC4.6U)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	TUAS 8DH	TUAS 8GH	TUAS 8JH	TUAS 8KH	TUAS 8MH	UNIT
Marking code on the device			AS8D	AS8G	AS8J	AS8K	AS8M	
Repetitive peak reverse voltage		V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	140	280	420	560	700	V
Forward current		I _F	8					Α
Surge peak forward current single half sinewave superimposed on rated load $t = 8.3 \text{ms}$ $t = 1.0 \text{ms}$					230			А
		I _{FSM}			580			Α
Junction temperature		T _J	-55 to +150					°C
Storage temperature T _{STG}		-55 to +150					°C	

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	4	°C/W	
Junction-to-ambient thermal resistance	R _{OJA}	38	°C/W	
Junction-to-case thermal resistance	R _{eJC}	8	°C/W	

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾		I _F = 4A, T _J = 25°C	V _F	0.90	-	V
		I _F = 8A, T _J = 25°C		0.96	1.10	V
		I _F = 4A, T _J = 125°C		0.78	-	V
		I _F = 8A, T _J = 125°C		0.87	-	V
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C		-	5	μΑ
		T _J = 125°C	- I _R	16	-	μΑ
TUAS8DH TUAS8GH Junction capacitance TUAS8JH		1MHz, V _R = 4.0V	С	62	-	pF
·	TUAS8KH TUAS8MH			54	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
TUAS8xH	TO-277A (SMPC4.6U)	6,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 200V(TUAS8DH) to 1000V(TUAS8MH)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

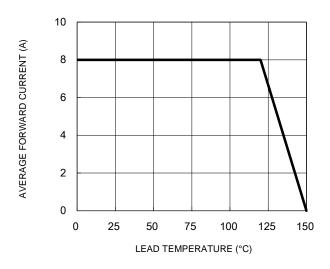


Fig.3 Typical Reverse Characteristics

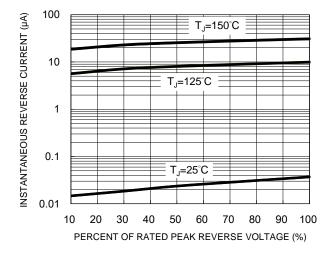


Fig.2 Typical Junction Capacitance

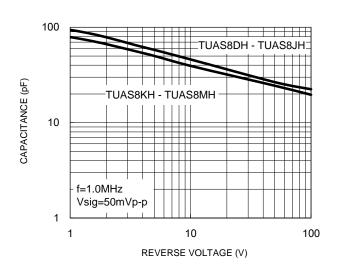


Fig.4 Typical Forward Characteristics

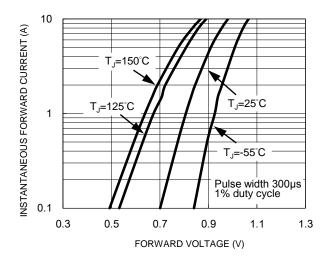
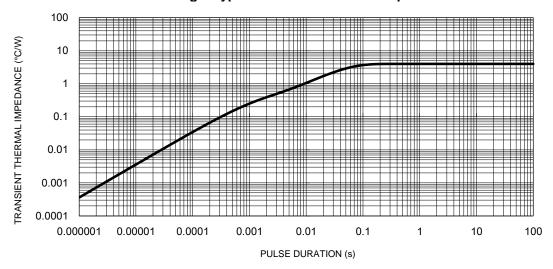


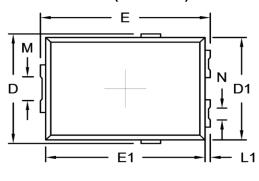
Fig.5 Typical Transient Thermal Impedance

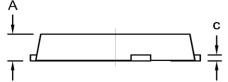


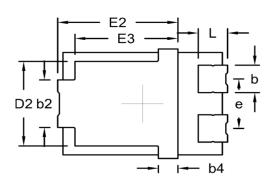


PACKAGE OUTLINE DIMENSIONS

TO-277A (SMPC4.6U)



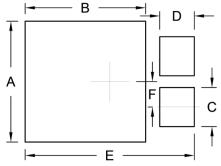




DIM.	Unit (mm)		Unit (inch)		
Dilvi.	' Min. Max.		Min.	Max.	
Α	1.00	1.20	0.039	0.047	
b	1.05	1.35	0.041	0.053	
b2	1.90	2.20	0.075	0.087	
b4	0.75 (NOM.)	0.030	0.030 (NOM.)	
С	0.15	0.40	0.006	0.016	
D	4.45	4.75	0.175	0.187	
D1	4.25	4.35	0.167	0.171	
D2	3.40	3.70	0.134	0.146	
E	6.35	6.65	0.250	0.262	
E1	6.05	6.15	0.238	0.242	
E2	4.40	4.80	0.173	0.189	
E3	3.94 (NOM.)	0.155 (NOM.)		
е	2.08 (NOM.)	0.082 (NOM.)		
L	0.94	1.24	0.037	0.049	
L1	0.05	0.35	0.002	0.014	
М	0.65	1.15	0.026	0.045	
N	0.25	0.75	0.010	0.030	

Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

SUGGESTED PAD LAYOUT

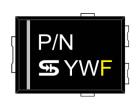


Symbol	Unit (mm)	Unit (inch)
Α	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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